

5-V Low Drop Fixed Voltage Regulator

TLE 4279



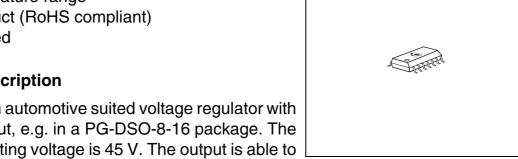


Features

- Output voltage tolerance $\leq \pm 2\%$
- 150 mA current capability
- Very low current consumption
- Early warning
- Reset output low down to $V_{\rm O}$ = 1 V
- Overtemperature protection
- Reverse polarity proof
- Adjustable reset threshold
- Very low-drop voltage
- Wide temperature range
- Green Product (RoHS compliant)
- **AEC Qualified**

Functional Description

This device is an automotive suited voltage regulator with a fixed 5-V output, e.g. in a PG-DSO-8-16 package. The maximum operating voltage is 45 V. The output is able to drive 150 mA load. It is short circuit protected and the



thermal shutdown switches the output off if the junction temperature is in excess of 150 °C. A reset signal is generated for an output voltage of $V_{\rm O}$ < 4.65 V. The reset threshold voltage can be decreased by external connection of a voltage divider. The reset delay time can be set by an external capacitor. If the application requires pull-up resistors at the logic outputs (Reset, Sense Out) the TLE 4269 with integrated resistors can be used. It is also possible to supervise the input voltage by using an integrated comparator to give a low voltage warning.

Туре	Package
TLE 4279 G	PG-DSO-8-16
TLE 4279 GM	PG-DSO-14-30

Data Sheet 1 Rev. 2.4, 2007-03-20



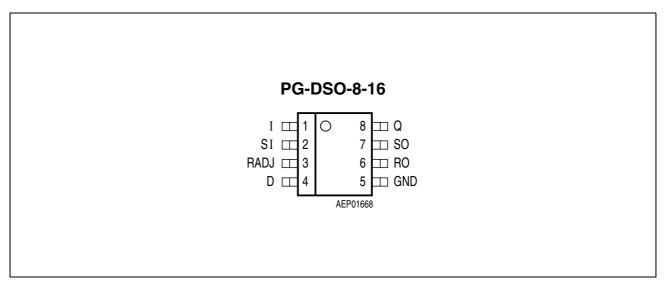


Figure 1 Pin Configuration (top view)

Table 1 Pin Definitions and Functions (TLE 4279 G)

Pin No.	Symbol	Function
1	I	Input; block to GND directly at the IC with a ceramic capacitor
2	SI	Sense input; if not needed connect to Q
3	RADJ	Reset threshold adjust; if not needed connect to ground
4	D	Reset delay; to select the delay time, connect to GND via external capacitor
5	GND	Ground
6	RO	Reset output; open-collector output. Keep open, if not needed
7	SO	Sense output; open-collector output. Keep open, if not needed
8	Q	5-V output; connect to GND with a 10 μ F capacitor, ESR < 10 Ω

Data Sheet 2 Rev. 2.4, 2007-03-20



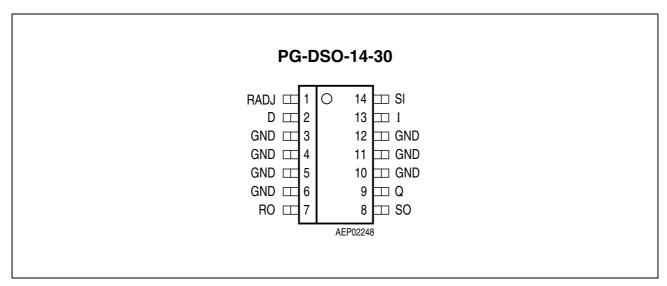


Figure 2 Pin Configuration (top view)

Table 2 Pin Definitions and Functions (TLE 4279 GM)

Pin No.	Symbol	Function
1	RADJ	Reset threshold adjust; if not needed connect to GND
2	D	Reset delay; connect to GND via external delay capacitor for setting delay time
3, 4, 5, 6	GND	Ground
7	RO	Reset output; open-collector output. Keep open, if not needed
8	SO	Sense output; open-collector output. Keep open, if not needed
9	Q	5-V output ; connect to GND via 10 μF capacitor, ESR < 10 Ω
10, 11, 12	GND	Ground
13	I	Input; block to GND directly at the IC by a ceramic capacitor
14	SI	Sense input; if not needed connect to Q

Data Sheet 3 Rev. 2.4, 2007-03-20



Circuit Description

The control amplifier compares a reference voltage, made highly accurate by resistance balancing, with a voltage proportional to the output voltage and drives the base of the series PNP transistor via a buffer. Saturation control as a function of the load current prevents any over-saturation of the power element.

The reset output RO is in high-state if the voltage on the delay capacitor $C_{\rm D}$ is greater or equal $V_{\rm UD}$. The delay capacitor $C_{\rm D}$ is charged with the current $I_{\rm D}$ for output voltages greater than the reset threshold $V_{\rm RT}$. If the output voltage gets lower than $V_{\rm RT}$ ('reset condition') a fast discharge of the delay capacitor $C_{\rm D}$ sets in and as soon as $V_{\rm D}$ gets lower than $V_{\rm LD}$ the reset output RO is set to low-level.

The time gap for the delay capacitor discharge is the reset reaction time t_{RR} .

The reset threshold $V_{\rm RT}$ can be decreased via an external voltage divider connected to the pin RADJ. In this case the reset condition is reached if $V_{\rm Q} < V_{\rm RT}$ and $V_{\rm RADJ} < V_{\rm RAQDJ,TH}$. Dimensioning the voltage divider (see **Figure 4**) according to:

$$V_{\text{THRES}} = V_{\text{RADJ,TH}} \times (R_{\text{RADJ1}} + R_{\text{RADJ2}}) / R_{\text{RADJ2}}, \tag{1}$$

the reset threshold can be decreased down to 3.5 V. If the reset-adjust-option is not needed the RADJ-pin should be connected to GND causing the reset threshold to go to its default value (typ. 4.65 V).

A built in comparator compares the signal of the pin SI, normally fed by a voltage divider from the input voltage, with the reference and gives an early warning on the pin SO. It is also possible to superwise another voltage e.g. of a second regulator, or to build a watchdog circuit with few external components.

Application Description

The input capacitor $C_{\rm I}$ is necessary for compensating line influences. Using a resistor of approx. 1 Ω in series with $C_{\rm I}$, the oscillating circuit consisting of input inductivity and input capacitance can be damped. The output capacitor $C_{\rm Q}$ is necessary for the stability of the regulating circuit. Stability is guaranteed at values \geq 10 μ F and an ESR \leq 10 Ω within the operating temperature range. Both reset output and sense output are open collector outputs and have to be connected to 5 V output via external pull-up resistors \geq 10 μ C. For small tolerances of the reset delay the spread of the capacitance of the delay capacitor and its temperature coefficient should be noted.

Data Sheet 4 Rev. 2.4, 2007-03-20



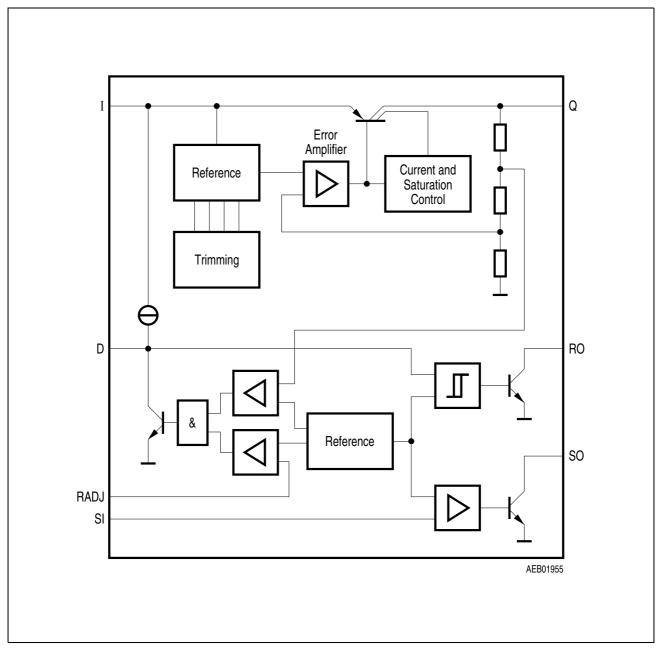


Figure 3 Block Diagram

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Table 3 Absolute Maximum Ratings

 $T_{\rm j}$ = -40 to 150 °C

Parameter	Symbol	Limi	t Values	Unit	Notes	
		Min.	Max.			
Input	1	-	1		,	
Input voltage	V_{I}	-40	45	V	_	
Input current	I_{I}	_	_	_	internal limited	
Sense Input			•		<u> </u>	
Input voltage	V_{SI}	-40	45	V	_	
Input current	I_{SI}	1	1	mA	_	
Reset Threshold			•			
Voltage	V_{RADJ}	-40	7	V	_	
Current	I_{RADJ}	-10	10	mA	_	
Reset Delay			•			
Voltage	V_{D}	-0.3	7	V	_	
Current	I_{D}	_	_	_	internal limited	
Ground			•		<u> </u>	
Current	I_{GND}	50	_	mA	_	
Reset Output			•			
Voltage	V_{R}	-0.3	7	V	_	
Current	I_{R}	_	_	_	internal limited	
Sense Output				·		
Voltage	V_{SO}	-0.3	7	V	_	
Current	I_{SO}	_	_	_	internal limited	
5-V Output				·		
Output voltage	V_{Q}	-0.5	7	V	_	
Output current	I_{Q}	-10	_	mA	_	
Temperature			•			
Junction temperature	T_{j}	_	150	°C	_	
		_	1			



Table 3 Absolute Maximum Ratings (cont'd)

 $T_{\rm i}$ = -40 to 150 °C

Parameter	Symbol	Limi	it Values	Unit	Notes
		Min.	Max.		
Operating Range	-	· ·	1	1	-
Input voltage	V_{I}	_	45	V	_
Junction temperature	$T_{\rm j}$	-40	150	°C	_
Thermal Data	-	•			
Junction-ambient	R_{thja}	_ _	200 70	K/W K/W	PG-DSO-8-16 PG-DSO-14-30
Junction-pin	R_{thjp}	_	30	K/W	PG-DSO-14-30

¹⁾ measured to Pin 4



Table 4 Characteristics

 $V_{\rm I}$ = 13.5 V; $T_{\rm j}$ = -40 °C < $T_{\rm j}$ < 125 °C

Parameter	Symbol	Limit Values			Unit	Measuring	
		Min.	Тур.	Max.		Condition	
Output voltage	V_{Q}	4.90	5.00	5.10	V	$\begin{array}{c} 1~\text{mA} \leq I_{\text{Q}} \leq 100~\text{mA} \\ 6~\text{V} \leq V_{\text{I}} \leq 16~\text{V} \end{array}$	
Current limit	I_{Q}	150	200	500	mA	_	
Current consumption; $I_q = I_l - I_Q$	I_{q}	_	150	300	μΑ	$I_{\rm Q} \le$ 1 mA, $T_{\rm j} <$ 85 °C	
Current consumption; $I_{q} = I_{l} - I_{Q}$	I_{q}	_	250	700	μΑ	I _Q = 10 mA	
Current consumption; $I_q = I_l - I_Q$	I_{q}	_	2	8	mA	$I_{\rm Q}$ = 50 mA	
Drop voltage	V_{dr}	_	0.25	0.5	V	$I_{\rm Q}$ = 100 mA ¹⁾	
Load regulation	ΔV_{Q}	_	10	30	mV	$I_{\rm Q}$ = 5 mA to 100 mA	
Line regulation	ΔV_{Q}	_	10	40	mV	$V_{\rm I}$ = 6 V to 26 V $I_{\rm Q}$ = 1 mA	
Reset Generator							
Switching threshold	V_{RT}	4.50	4.65	4.80	V	_	
Reset adjust switching voltage	$V_{RADJ,TH}$	1.26	1.35	1.44	V	V _Q > 3.5 V	
Reset low voltage	$V_{RO,SAT}$	_	0.1	0.4	V	$R_{\rm extern} = 20 \text{ k}\Omega$	
Upper delay switching threshold	V_{UD}	1.4	1.8	2.2	V	_	
Lower delay switching threshold	V_{LD}	0.3	0.45	0.60	V	_	
Reset delay low voltage	$V_{D,SAT}$	_	_	0.1	V	$V_{\rm Q} < V_{\rm RT}$	
Charge current	I_{D}	3.0	6.5	9.5	μΑ	V_{D} = 1 V	
$\overline{\text{Delay time L} \to \text{H}}$	t_{d}	17	28	_	ms	$C_{\rm D}$ = 100 nF	
Delay time $H \rightarrow L$	t_{t}	_	1	_	μs	$C_{\rm D} = 100 \; {\rm nF}$	



Table 4Characteristics (cont'd)

 $V_{\rm I}$ = 13.5 V; $T_{\rm j}$ = -40 °C < $T_{\rm j}$ < 125 °C

Parameter	Symbol	Limit Values			Unit	Measuring
		Min.	Тур.	Max.		Condition
Input Voltage Sense	-	1	1	1	•	
Sense threshold high	$V_{ m SI,\ high}$	1.24	1.31	1.38	V	_
Sense threshold low	$V_{ m SI,\ low}$	1.16	1.20	1.28	V	_
Sense output low voltage	$V_{SO,\ low}$	_	0.1	0.4	V	$\begin{aligned} V_{\rm SI} < \text{1.20 V}; \\ V_{\rm Q} > \text{3 V}; \\ R_{\rm extern} = \text{20 k}\Omega \end{aligned}$
Sense input current	I_{SI}	-1	0.1	1	μΑ	_

¹⁾ Drop voltage = $V_{\rm l}$ - $V_{\rm Q}$ (measured when the output voltage has dropped 100 mV from the nominal value obtained at 13.5 V input.)

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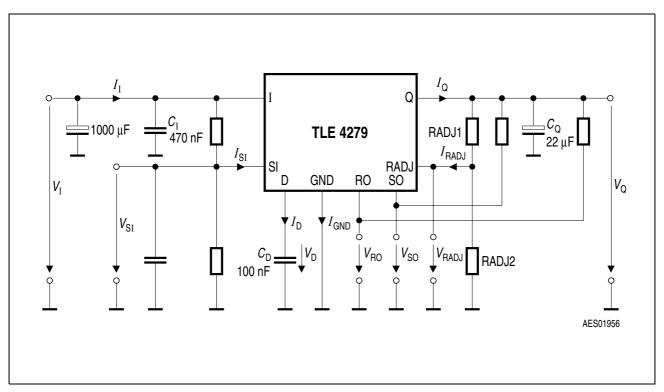


Figure 4 Measuring Circuit

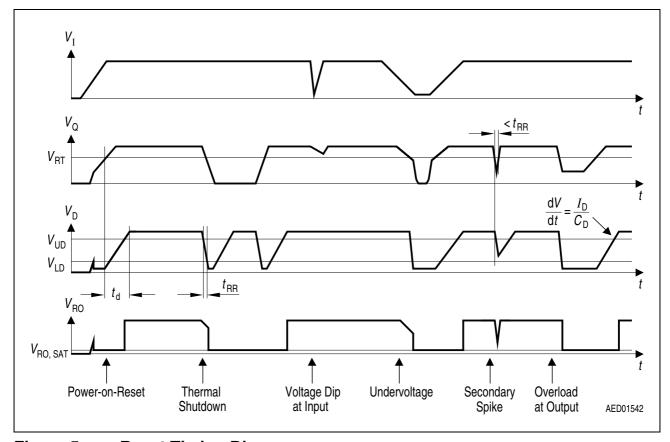


Figure 5 Reset Timing Diagram



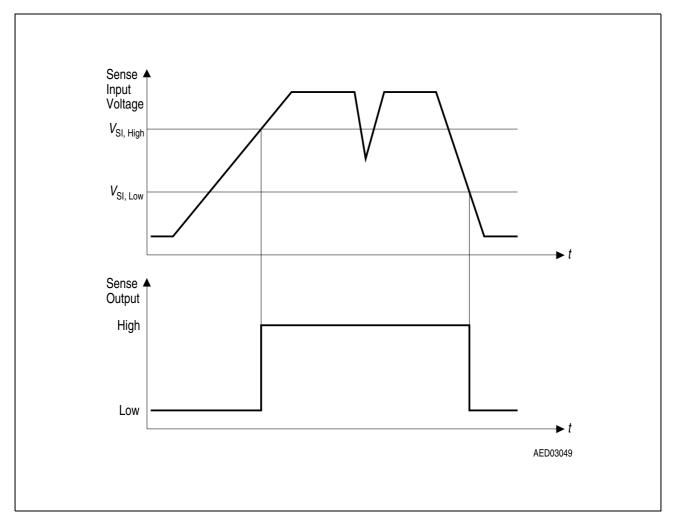
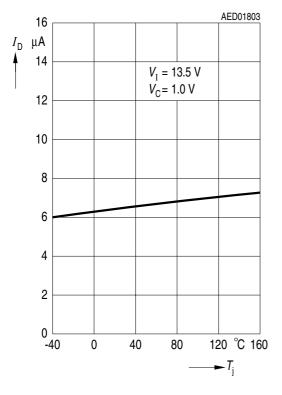


Figure 6 Sense Input Timing Diagram

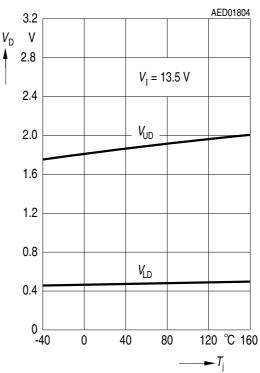
Data Sheet 11 Rev. 2.4, 2007-03-20



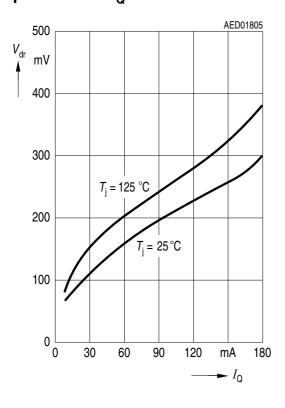
Charge Current $I_{\rm D}$ versus Temperature $T_{\rm i}$



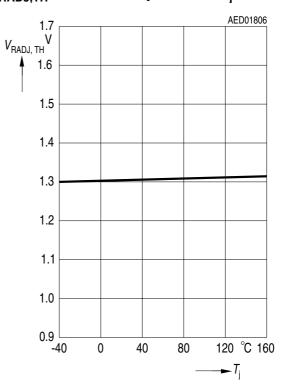
Switching Voltage $V_{\rm UD}$ and $V_{\rm LD}$ versus Temperature $T_{\rm i}$



Drop Voltage $V_{ m dr}$ versus Output Current $I_{ m O}$

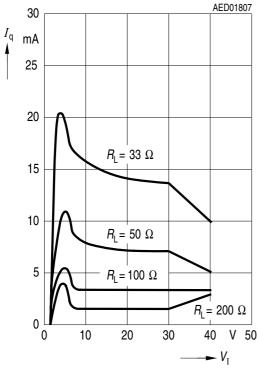


Reset Adjust Switching Threshold $V_{\mathsf{RADJ}.\mathsf{TH}}$ versus Temperature T_{i}

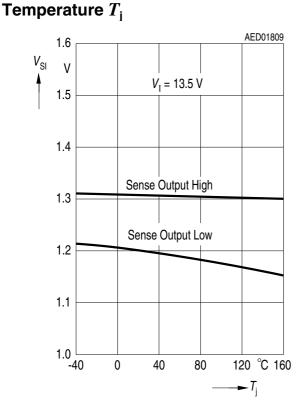




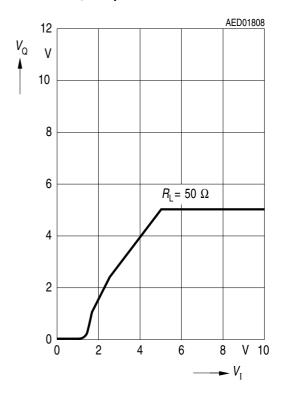
Current Consumption I_{Q} versus Input Voltage V_{I}



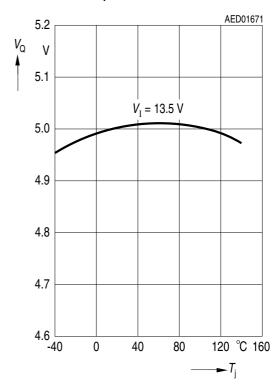
Sense Threshold V_{SI} versus



Output Voltage $V_{\rm Q}$ versus Input Voltage $V_{\rm I}$

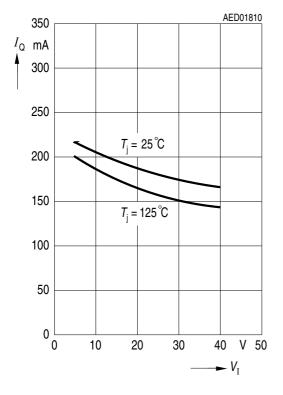


Output Voltage V_{Q} versus Temperature T_i

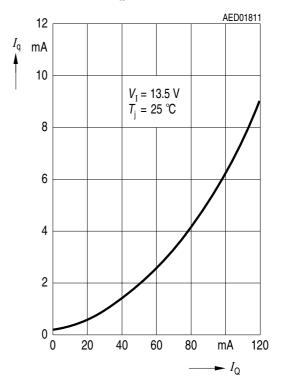




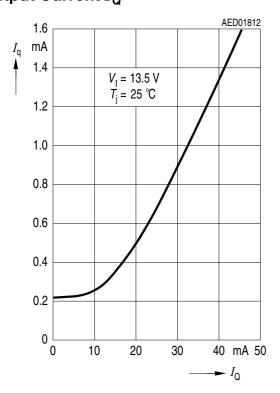
Output Current I_{Q} versus Input Voltage V_{I}



Current Consumption $I_{\rm q}$ versus Output Current $I_{\rm Q}$



Current Consumption $I_{\rm q}$ versus Output Current $I_{\rm Q}$





Package Outlines

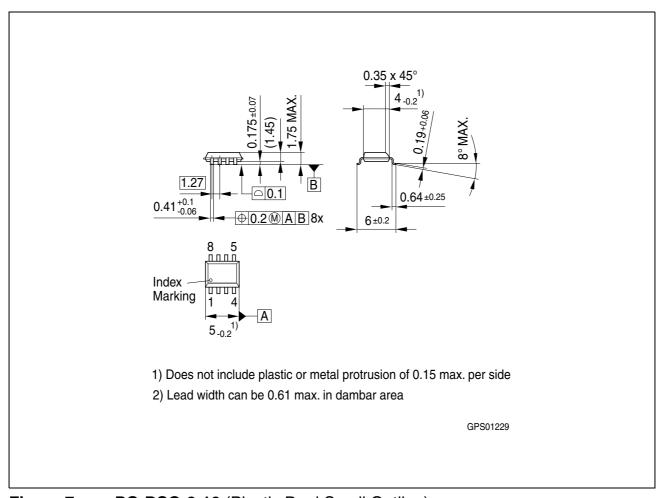


Figure 7 PG-DSO-8-16 (Plastic Dual Small Outline)

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

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SMD = Surface Mounted Device

Dimensions in mm



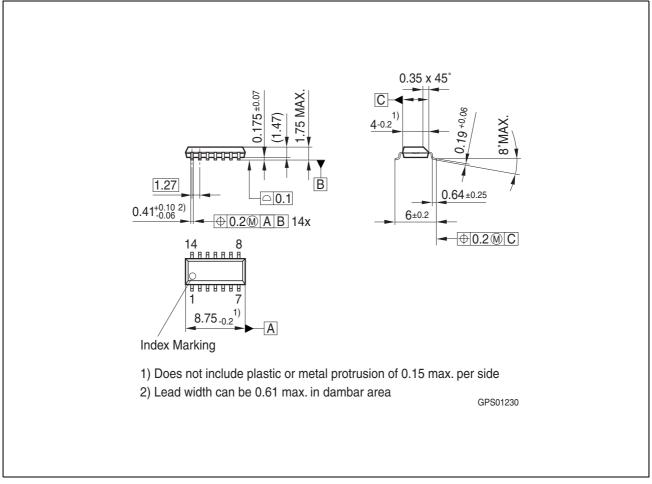


Figure 8 PG-DSO-14-30 (Plastic Dual Small Outline)

Green Product (RoHS compliant)

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SMD = Surface Mounted Device

Dimensions in mm



Revision History

Version	Date	Changes
Rev. 2.4	2007-03-20	Initial version of RoHS-compliant derivate of TLE 4279 Page 1: AEC certified statement added Page 1 and Page 15f: RoHS compliance statement and Green product feature added Page 1 and Page 15f: Packages changed to RoHS compliant version Legal Disclaimer updated

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